# ☐ MN101C62D, MN101C62F

Туре	MN101C62D [ES (Engineering Sample) available]	MN101C62F (under development)				
ROM (×8-bit)	64 K	96 K				
RAM (×8-bit)	2 К	4 K				
Package	LQFP080-P-1414	4A *Lead-free				
Minimum Instruction Execution Time	Standard: 0.10 μs (at 4.5 V to 5.5 V, 20 MHz)  0.25 μs (at 2.7 V to 5.5 V, 8 MHz)  1.00 μs (at 2.0 V to 5.5 V, 2 MHz)*  125 μs (at 2.0 V to 5.5 V, 32 kHz)*	Double speed: 0.125 μs (at 4.5 V to 5.5 V, 8 MHz)  MHz) 0.25 μs (at 3.0 V to 5.5 V, 4 MHz)  MHz)* 62.5 μs (at 2.0 V to 5.5 V, 32 kHz)*				
_	* The lower limit for operation guarantee for flash memory built-in type is 2.5 V.					
Interrupts	• Watchdog • External 0 • External 1 • External 2 • External 3 • External 4 • Timer 0 • Timer 1 • Timer 2 • Timer 3 • Timer 4 • Timer 6 • Time base • Timer 7 (2 systems) • Timer 8 (2 systems) • Automatic transfer completion • Serial 0 (2 systems) • Serial 1 (2 systems) • Serial 2 • A/D conversion finish • Key interrupt					
Timer Counter	Timer counter 0: 8-bit × 1  (square-wave/8-bit PWM output, event count, generation of remote control carrier, simple pulse width measurement)  Clock source					
	Timer counter 1: 8-bit × 1 (square-wave output, event count, synchronous output event, serial baud rate timer)  Clock source					
	Timer counter 0, 1 can be cascade-connected.					
	Timer counter 2: 8-bit × 1  (square-wave output, event count, sychronous output event, simple pulse width measurement, generation of real time, serial baud rate timer)  Clock source					
	Timer counter 3: 8-bit × 1  (square-wave output, event count, generation of remote  Clock source	control carrier, serial baud rate timer) k frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC ency; 1/1 of XI oscillation clock frequency; external				
	Timer counter 2, 3 can be cascade-connected.					
	·	k frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation XI oscillation clock frequency; external clock input				
		quency; 1/1, 1/128, 1/8192 of OSC oscillation clock 1/8192 of XI oscillation clock frequency are register 6				

### **Timer Counter** (Continue)

Timer counter 7: 16-bit  $\times$  1

(square-wave output, 16-bit PWM output (cycle / duty continuous variable), event count, synchronous output evevt, pulse width measurement, input capture, generation of real time)

oscillation clock frequency; 1/1, 1/2, 1/4, 1/16 of external clock input frequency

Interrupt source ..... coincidence with compare register 7 (2 lines)

Watchdog timer

Interrupt source ----- 1/65536, 1/262144, 1/1048576 of system clock frequency

Timer counter 8:16-bit  $\times 1$ 

(square-wave output, 16-bit PWM output (cycle / duty continuous variable), event count, synchronous output evevt, pulse width measurement, input capture, generation of real time)

oscillation clock frequency; 1/1, 1/2, 1/4, 1/16 of external clock input frequency

Interrupt source ..... coincidence with compare register 7 (2 lines)

Watchdog timer

Interrupt source ----- 1/65536, 1/262144, 1/1048576 of system clock frequency

#### Serial Interface

Serial 0 : synchronous type/UART (full-duplex)  $\times$  1

1/2, 1/4, 1/16, 1/64 of OSC oscillation clock frequency

Serial 1: synchronous type/UART (full-duplex) × 1

Clock source ------ 1/2, 1/4 of system clock frequency; pulse output of timer counter 2 or 3;

1/2,1/8 of timer counter 2 output;

1/2, 1/4, 1/16, 1/64 of OSC oscillation clock frequency

Serial 2 : synchronous type / single-master I<sup>2</sup>C

1/2, 1/4, 1/8, 1/32 of OSC oscillation clock frequency

A/D Inputs 10-bit  $\times$  8-ch. (with S/H)

**Special Ports** 

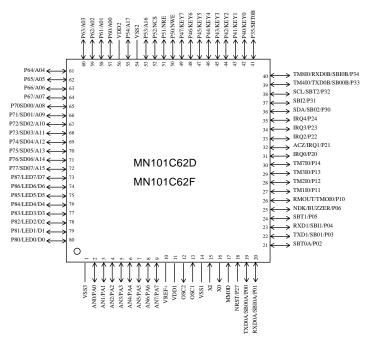
Buzzer output, remote control carrier signal output, high-current drive port

#### **Electrical Characteristics**

#### Supply current

Parameter	Symbol	Condition	Limit			Unit
raiametei		Condition	min	typ	max	Offic
Operating cumply current	IDD1	fosc = 20  MHz,  VDD = 5  V		18	30	mA
Operatingsupplycurrent	IDD2	fx = 32  kHz, VDD = 3  V		30	60	μА
Supply current at HALT	IDD3	$fx = 32 \text{ kHz}, VDD = 3 \text{ V}, Ta = 25^{\circ}\text{C}$		6	8	μА
Supply culteritat HALI	IDD4	$fx = 32 \text{ kHz}, VDD = 3 \text{ V}, Ta = 85^{\circ}\text{C}$			30	μА
Supply current at STOP	IDD5	$VDD = 5 \text{ V}, \text{ Ta} = 25^{\circ}\text{C}$			2	μА
Supply current at STOP	IDD6	$VDD = 5 \text{ V}, \text{ Ta} = 85^{\circ}\text{C}$			50	μА

## Pin Assignment



LQFP080-P-1414A \*Lead-free

## **Support Tool**

In-circuit Emulator	PX-ICE101C / D + PX-PRB101C62-LQFP080-P-1414A-M (under development)	
Flash Memory Built-in Type	Туре	MN101CF62G (under development)
	ROM (× 8-bit)	128 K
	RAM (× 8-bit)	10 K
	Minimum instruction execution time	0.1 μs (at 4.5 V to 5.5 V, 20 MHz)
		$0.25~\mu s$ (at $3.0V$ to $5.5~V,~8~MHz)$
		$62.5~\mu s$ (at $3.0~V$ to $5.5~V,32~kHz)$
	Package	LQFP080-P-1414A *Lead-free

MN101C62D , MN101C62F  $\square$ 

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